Example

To enhance heat transfer form a silicon chip, a copper pin fin is brazed to the surface of the chip. The pin length and diameter are L = 12 mm and D = 2 mm, respectively. The surface of the chip, and hence the base of the pin are maintained at a temperature of $T_b = 350$ K. The pin is subject to atmospheric air in cross flow with V = 10 m/s and $T_{\infty} = 300$ K

- (a) What is the average convection coefficient for the surface of the pin?
- (b) Assuming *h* at the tip of the fin to be the same as that calculated in (a), calculate the heat transfer rate from the pin. (I.e., assume an insulated tip with a corrected fin length.)

